# National Semiconductor

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# LM4836 Boomer<sup>®</sup> Audio Power Amplifier Series Stereo 2W Audio Power Amplifiers with DC Volume Control, Bass Boost, and Input Mux

### **General Description**

The LM4836 is a monolithic integrated circuit that provides DC volume control, and stereo bridged audio power amplifiers capable of producing 2W into  $4\Omega$  (Note 1) with less than 1.0% THD+N, or 2.2W into  $3\Omega$  (Note 2) with less than 1.0% THD+N.

Boomer® audio integrated circuits were designed specifically to provide high quality audio while requiring a minimum amount of external components. The LM4836 incorporates a DC volume control, stereo bridged audio power amplifiers, selectable gain or bass boost, and an input mux making it optimally suited for multimedia monitors, portable radios, desktop, and portable computer applications.

The LM4836 features an externally controlled, low-power consumption shutdown mode, and both a power amplifier and headphone mute for maximum system flexibility and performance.

Note 1: When properly mounted to the circuit board, the LM4836MTE will deliver 2W into  $4\Omega$ . The LM4836MT will deliver 1.1W into  $8\Omega$ . See the Application Information section for LM4836MTE usage information.

Note 2: An LM4836MTE which has been properly mounted to the circuit board and forced-air cooled will deliver 2.2W into  $3\Omega$ .

# **Key Specifications**

| ■ P <sub>o</sub> at 1% THD+N                                       |            |
|--|------------|
| into 3Ω (LM4836MTE)  | 2.2W(typ)  |
| into $4\Omega$ (LM4836MTE)   | 2.0W(typ)  |
| into 8Ω (LM4836)   | 1.1W(typ)  |
| <ul> <li>Single-ended mode - THD+N<br/>at 85mW into 32Ω</li> </ul> | 1.0%(typ)  |
| Shutdown current   | 0.2µA(typ) |

#### -----

## Features

- PC98 and PC99 Compliant
- DC Volume Control Interface
- Input mux
- System Beep Detect
- Stereo switchable bridged/single-ended power amplifiers
- Selectable internal/external gain and bass boost configurable
- "Click and pop" suppression circuitry
- Thermal shutdown protection circuitry

### **Applications**

- Portable and Desktop Computers
- Multimedia Monitors
- Portable Radios, PDAs, and Portable TVs

# **Connection Diagram**

| 1350                           | P Package                               |
|--------------------------------|---|
| SND 1<br>Mux Control 2         | 28 - Right Out+<br>27 - V <sub>DD</sub> |
| Mute — 3                       | 26 Right Out-                           |
| V <sub>DD</sub> — 4            | 25 Right Bass Boost                     |
| DC Vol - 5                     | 24 — Shutdown                           |
| GND — 6                        | 23 GND                                  |
| Left in 2 - 7                  | 22 Bypass                               |
| Right In 2 - 8                 | 21 HP Sense                             |
| Right Dock — 9                 | 20 GND                                  |
| Right In 1 10                  | 19 Bass Boost Select                    |
| Beep In → 11<br>Left In 1 → 12 | 18 - Left Bass Boost<br>17 - Left Out-  |
| Left Dock - 13                 |   |
| GND - 14                       | 15 Left Out+                            |
| 010                            |   |
|                                | DS101088-2                              |
| 1                              | op View                                 |
| Order Nu                       | mber LM4836MT                           |
| See NS Package N               | lumber MTC28 for TSSOP                  |
|                                | nber LM4836MTE                          |
|                                |   |
| See NS Package Number          | WXA28A for Exposed DAP TSSOP            |
| -                              |   |
|                                |   |
|                                |   |
|                                |   |
|                                |   |

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LM4836 Stereo 2W Audio Power Amplifiers with DC Volume Control, Bass Boost, and Input Mux

# Absolute Maximum Ratings (Note 10)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

| Supply Voltage               | 6.0V                           |
|------------------------------|--------------------------------|
| Storage Temperature          | -65°C to +150°C                |
| Input Voltage                | –0.3V to V <sub>DD</sub> +0.3V |
| Power Dissipation            | Internally limited             |
| ESD Susceptibility (Note 12) | 2500V                          |
| ESD Susceptibility (Note 13) | 250V                           |
| Junction Temperature         | 150°C                          |
| Soldering Information        |                                |
| Vapor Phase (60 sec.)        | 215°C                          |
| Infrared (15 sec.)           | 220°C                          |

See AN-450 "Surface Mounting and their Effects on Product Reliability" for other methods of soldering surface mount devices.

| $\theta_{\rm JC}$ (typ) — MTC28       | 20°C/W |
|---------------------------------------|--------|
| θ <sub>JA</sub> (typ)—MTC28           | 80°C/W |
| θ <sub>JC</sub> (typ)—MXA28A          | 2°C/W  |
| $\theta_{JA}$ (typ) — MXA28A (Note 4) | 41°C/W |
| $\theta_{JA}$ (typ) — MXA28A (Note 3) | 54°C/W |
| $\theta_{JA}$ (typ) — MXA28A (Note 5) | 59°C/W |
| $\theta_{JA}$ (typ) — MXA28A (Note 6) | 93°C/W |
|                                       |        |

# **Operating Ratings**

| Temperature Range                 |                                       |
|-----------------------------------|---------------------------------------|
| $T_{MIN} \leq T_{A} \leq T_{MAX}$ | $-40^{\circ}C \le TA \le 85^{\circ}C$ |
| Supply Voltage                    | 2.7V≤ V <sub>DD</sub> ≤ 5.5V          |

# **Electrical Characteristics for Entire IC**

(Notes 7, 10) The following specifications apply for  $V_{\rm DD}$  = 5V and  $T_{\rm A}$  = 25°C unless otherwise noted.

| Symbol Parameter | Conditions                         | LM4                                   | LM4836             |                   |          |
|------------------|------------------------------------|---------------------------------------|--------------------|-------------------|----------|
|                  |                                    | Typical<br>(Note 14)                  | Limit<br>(Note 15) | Units<br>(Limits) |          |
| V <sub>DD</sub>  | Supply Voltage                     |                                       |                    | 2.7               | V (min)  |
|                  |                                    |                                       |                    | 5.5               | V (max)  |
| I <sub>DD</sub>  | Quiescent Power Supply Current     | $V_{IN} = 0V, I_O = 0A$               | 15                 | 30                | mA (max) |
| I <sub>SD</sub>  | Shutdown Current                   | V <sub>pin 24</sub> = V <sub>DD</sub> | 0.2                | 2.0               | µA (max) |
| V <sub>IH</sub>  | Headphone Sense High Input Voltage |                                       |                    | 4                 | V (min)  |
| V <sub>IL</sub>  | Headphone Sense Low Input Voltage  |                                       |                    | 0.8               | V (max)  |

# **Electrical Characteristics for Volume Attenuators**

(Notes 7, 10) The following specifications apply for  $V_{DD} = 5V$  and  $T_A = 25^{\circ}C$  unless otherwise noted.

|                |                  |                                       | LM4836               |                    | Units    |
|----------------|------------------|---------------------------------------|----------------------|--------------------|----------|
| Symbol         | Parameter        | Conditions                            | Typical<br>(Note 14) | Limit<br>(Note 15) | (Limits) |
| CRANGE         | Attenuator Range | Gain with V <sub>pin 5</sub> ≥ 4.5V   | 0                    | ±0.5               | dB (max) |
|                |                  |                                       | 0                    | -1.0               | dB (min) |
| CRANGE         | Attenuator Range | Attenuation with $V_{pin 5} = 0V$     | -73                  | -70                | dB (min) |
| A <sub>M</sub> | Mute Attenuation | V <sub>pin 3</sub> = 5V, Bridged Mode | -88                  | -80                | dB (min) |
|                |                  | $V_{pin 3} = 5V$ , Single-Ended Mode  | -80                  | -70                | dB (min) |

# Electrical Characteristics for Single-Ended Mode Operation

(Notes 7, 10) The following specifications apply for  $V_{\text{DD}}$  = 5V and  $T_{\text{A}}$  = 25  $^{\circ}\text{C}$  unless otherwise noted.

|                  |              |  | LM4                | 836      | Units |
|------------------|--------------|--|--------------------|----------|-------|
| Symbol Parameter | Conditions   | Typical<br>(Note 14)                                   | Limit<br>(Note 15) | (Limits) |       |
| Po               | Output Power | THD+N = 1.0%; f = 1kHz;<br>R <sub>L</sub> = $32\Omega$ | 85                 |          | mW    |
|                  |              | THD+N = 10%; f = 1 kHz; $R_{L}$ = $32\Omega$           | 95                 |          | mW    |
|                  |              |  |                    |          |       |

| Electr                    | Electrical Characteristics for Single-Ended Mode Operation (Continued) |   |                      |                    |          |
|---------------------------|--|---|----------------------|--------------------|----------|
| (Notes 7, 1<br>The follow |  | and $T_A = 25^{\circ}C$ unless otherwise noted.   |                      |                    |          |
|                           |  |   | LM4                  | 836                | Units    |
| Symbol                    | Parameter  | Conditions  | Typical<br>(Note 14) | Limit<br>(Note 15) | (Limits) |
| THD+N                     | Total Harmonic Distortion+Noise  | $V_{OUT} = 1V_{RMS}$ , f=1kHz, R <sub>L</sub> = 10k $\Omega$ ,<br>A <sub>VD</sub> = 1               | 0.065                |                    | %        |
| PSRR                      | Power Supply Rejection Ratio   | $C_B = 1.0 \ \mu\text{F}, \text{ f} = 120 \ \text{Hz},$<br>$V_{\text{RIPPLE}} = 200 \ \text{mVrms}$ | 58                   |                    | dB       |
| SNR                       | Signal to Noise Ratio  | $P_{OUT}$ =75 mW, R $_{L}$ = 32 $\Omega$ , A-Wtd Filter   | 102                  |                    | dB       |
| X <sub>talk</sub>         | Channel Separation   | f=1kHz, $C_B = 1.0 \ \mu F$   | 65                   |                    | dB       |

# **Electrical Characteristics for Bridged Mode Operation**

(Notes 7, 10) The following specifications apply for  $V_{DD}$  = 5V and  $T_A$  = 25°C unless otherwise noted.

|                   |                                 |  | LM4836 |                    | Unite             |
|-------------------|---------------------------------|--|--------|--------------------|-------------------|
| Symbol            | Parameter                       | Parameter Conditions   |        | Limit<br>(Note 15) | Units<br>(Limits) |
| Vos               | Output Offset Voltage           | $V_{IN} = 0V$  | 10     | 50                 | mV (max)          |
| Po                | Output Power                    | THD + N = 1.0%; f=1kHz; $R_{L} = 3\Omega$<br>(Note 8)  | 2.2    |                    | W                 |
|                   |                                 | THD + N = 1.0%; f=1kHz; $R_{L} = 4\Omega$<br>(Note 9)(Note 15)   | 2      |                    | W                 |
|                   |                                 | THD = 1.5% (max);f = 1 kHz;<br>R <sub>L</sub> = $8\Omega$  | 1.1    | 1.0                | W (min)           |
|                   |                                 | THD+N = 10%;f = 1 kHz; $R_{L} = 8\Omega$   | 1.5    |                    | W                 |
| THD+N             | Total Harmonic Distortion+Noise | $P_{O} = 1W$ , 20 Hz< f < 20 kHz,<br>R <sub>L</sub> = 8Ω, A <sub>VD</sub> = 2                              | 0.3    |                    | %                 |
|                   |                                 | $P_{O} = 340 \text{ mW}, R_{L} = 32\Omega$   | 1.0    |                    | %                 |
| PSRR              | Power Supply Rejection Ratio    | $C_B = 1.0 \ \mu\text{F}, f = 120 \ \text{Hz},$<br>$V_{\text{RIPPLE}} = 200 \ \text{mVrms}; R_L = 8\Omega$ | 74     |                    | dB                |
| SNR               | Signal to Noise Ratio           | $V_{DD} = 5V, P_{OUT} = 1.1W, R_{L} = 8\Omega,$<br>A-Wtd Filter  | 93     |                    | dB                |
| X <sub>talk</sub> | Channel Separation              | f=1kHz, C <sub>B</sub> = 1.0 μF  | 70     |                    | dB                |

**Note 3:** The  $\theta_{JA}$  given is for an MXA28A package whose exposed-DAP is soldered to an exposed 2ln<sup>2</sup> piece of 1 ounce printed circuit board copper. **Note 4:** The  $\theta_{JA}$  given is for an MXA28A package whose exposed-DAP is soldered to a 2in<sup>2</sup> piece of 1 ounce printed circuit board copper on a bottom side layer

Note 4: The 0<sub>JA</sub> given is for an MXA28A package whose exposed-DAP is soldered to a 2in<sup>2</sup> piece of 1 ounce printed circuit board copper on a bottom si through 21 8mil vias.

Note 5: The  $\theta_{JA}$  given is for an MXA28A package whose exposed-DAP is soldered to an exposed 1in<sup>2</sup> piece of 1 ounce printed circuit board copper. Note 6: The  $\theta_{JA}$  given is for an MXA28A package whose exposed-DAP is not soldered to any copper.

Note 7: All voltages are measured with respect to the ground pins, unless otherwise specified. All specifications are tested using the typical application as shown in Figure 2.

Note 8: When driving 3Ω loads from a 5V supply the LM4836MTE exposed DAP must be soldered to the circuit board and forced-air cooled.

Note 9: When driving  $4\Omega$  loads from a 5V supply the LM4836MTE exposed DAP must be soldered to the circuit board.

Note 10: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. The device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

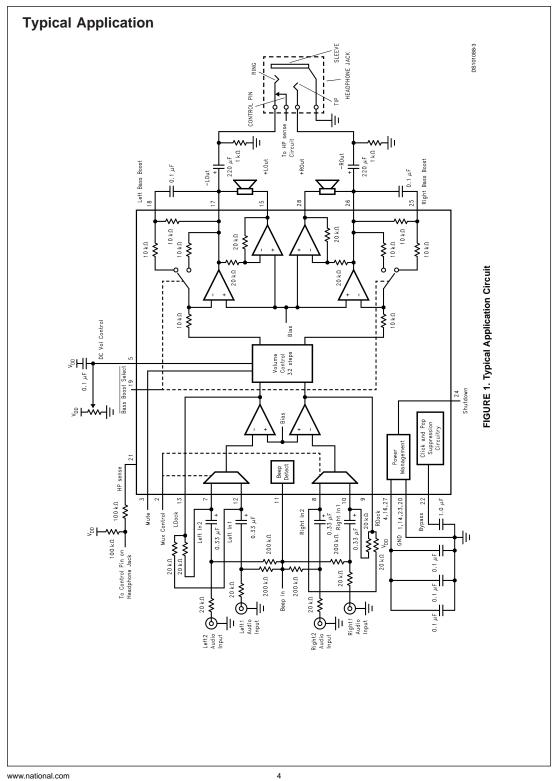
Note 11: The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{JMAX}$ ,  $\theta_{JA}$ , and the ambient temperature  $T_A$ . The maximum allowable power dissipation is  $P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA}$ . For the LM4836MT,  $T_{JMAX} = 150$ °C, and the typical junction-to-ambient thermal resistance, when board mounted, is 80°C/W assuming the MTC28 package.

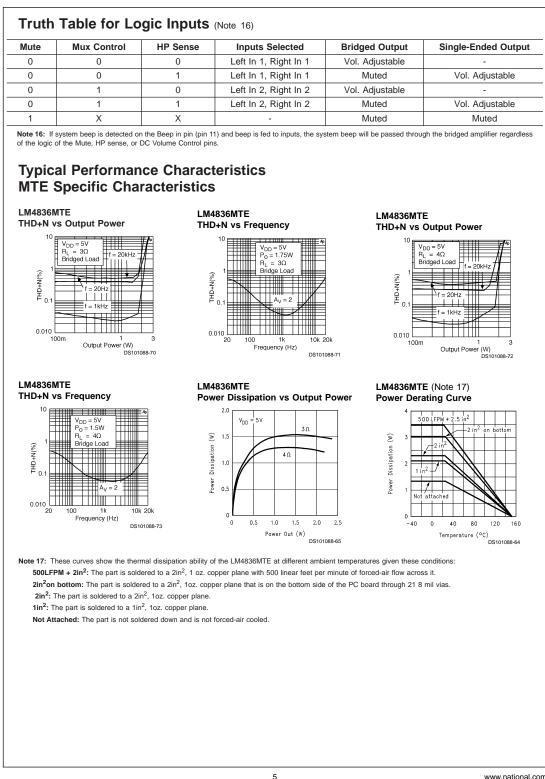
Note 12: Human body model, 100 pF discharged through a 1.5  $k\Omega$  resistor.

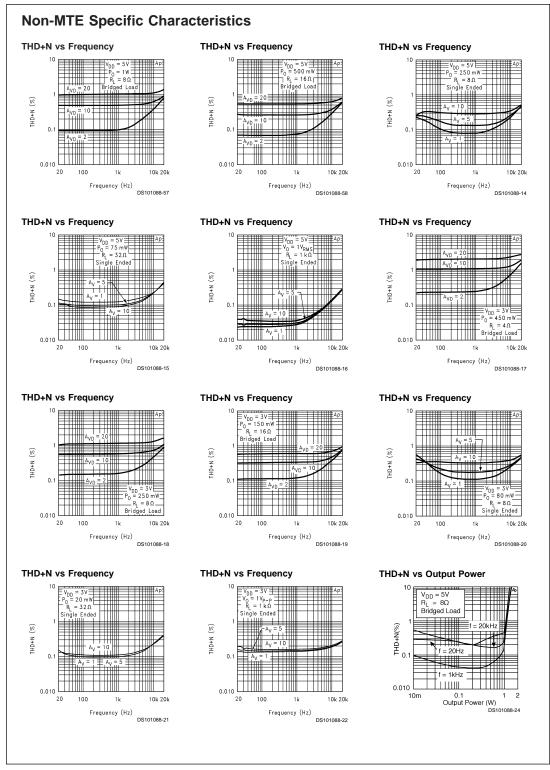
Note 13: Machine Model, 220 pF-240 pF discharged through all pins.

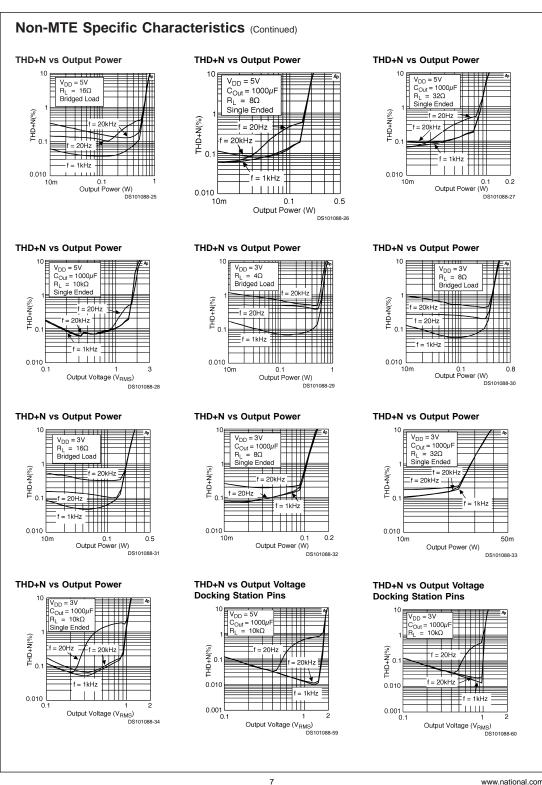
Note 14: Typicals are measured at 25°C and represent the parametric norm.

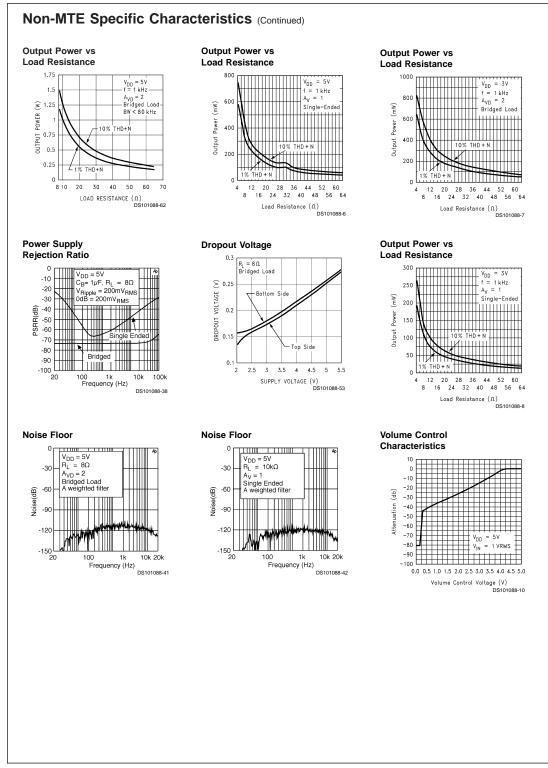
Note 15: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).



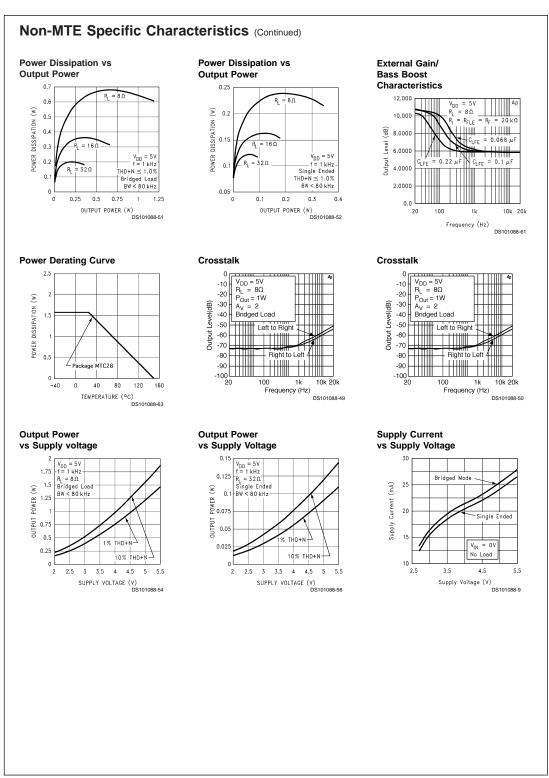








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# **Application Information**

#### EXPOSED-DAP MOUNTING CONSIDERATIONS

The exposed-DAP (die attach pad) must be tied to ground. The exposed-DAP of the LM4836MTE requires special attention to thermal design. If thermal design issues are not properly addressed, an LM4836MTE driving 4 $\Omega$  will go into thermal shutdown.

The exposed-DAP on the bottom of the LM4836MTE should be soldered down to a copper plane on the circuit board. The copper plane will conduct heat away from the exposed-DAP. If the copper plane is not on the top surface of the circuit board, 20 to 30 vias of 0.010 inches or smaller in diameter should be used to thermally couple the exposed-DAP to the plane. For good thermal conduction, the vias must be plated-through and solder-filled.

The copper plane used to conduct heat away from the exposed-DAP should be as large as practical. If the plane is on the same side of the circuit board as the exposed-DAP, 2 in<sup>2</sup> is the minimum for 5V operation into  $4\Omega$ . If the heat sink plane is buried or not on the same side as the exposed-DAP,  $5in^2$  is the minimum for 5V operation into  $4\Omega$ . If the ambient temperature is higher than 25°C, a larger copper plane or forced-air cooling may be required to keep the LM4836MTE junction temperature below the thermal shutdown temperature (150°C). See the power derating curve for the LM4836MTE for derating information.

The LM4836MTE requires forced-air cooling when operating into  $3\Omega$ .

#### POWER DISSIPATION

Power dissipation is a major concern when using any power amplifier and must be thoroughly understood to ensure a successful design. Equation 1 states the maximum power dissipation point for a single-ended amplifier operating at a given supply voltage and driving a specified load.

#### $P_{DMAX} = (V_{DD})^2 / (2\pi {}^2R_L)$ (1)

However, a direct consequence of the increased power delivered to the load by a bridged amplifier is an increase in internal power dissipation. Equation 2 states the maximum power dissipation point for a bridged amplifier operating at a given supply voltage and driving a specified load.

#### $P_{DMAX} = 4(V_{DD})^2/(2\pi {}^2R_L)$ (2)

Since the LM4836 is a stereo power amplifier, the maximum internal power dissipation is two times that of Equation 1 or Equation 2 depending on the mode of operation. Even with the power dissipation of the stereo amplifiers, the LM4836 does not require heatsinking. The power dissipation from the amplifiers, must not be greater than the package power dissipation that results from Equation 3:

#### $P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA} \quad (3)$

For the LM4836 TSSOP package,  $\theta_{JA} = 80^{\circ}$ C/W and  $T_{JMAX} = 150^{\circ}$ C. Depending on the ambient temperature,  $T_{A}$ , of the system surroundings, Equation 3 can be used to find the maximum internal power dissipation supported by the IC packaging. If the result of Equation 1 and 2 is greater than that of Equation 3, then either the supply voltage must be decreased, the load impedance increased, or the ambient temperature reduced. For the typical application of a 5V power supply, with an 8 $\Omega$  bridged loads, the maximum junction temperature is approximately 48°C provided that device operation is around the maximum power dissipation points.

typical operation is not around the maximum power dissipation point, the ambient temperature can be increased. Refer to the **Typical Performance Characteristics** curves for power dissipation information for different output powers.

#### LAYOUT

As stated in the Grounding section, placement of ground return lines is imperative in maintaining the highest level of system performance. It is not only important to route the correct ground return lines together, but also to be aware of where the ground return lines are routed with respect to each other. The output load ground returns should be physically located as far as possible from low signal level lines and their ground return lines.

#### 3 $\Omega$ and 4 $\Omega$ Layout Considerations

With low impedance loads, the output power at the loads is heavily dependent on trace resistance from the output pins of the LM4836. Traces from the output of the LM4836MTE to the load or load connectors should be as wide as practical. Any resistance in the output traces will reduce the power delivered to the load. For example, with a 4 $\Omega$  load and 0.1 $\Omega$  of trace resistance in each output, output power at the load drops from 2W to 1.8W.

Output power is also dependent on supply regulation. To keep the supply voltage from sagging under full output conditions, the supply traces should be as wide as practical.

#### Grounding

In order to achieve the best possible performance, there are certain grounding techniques to be followed. All input reference grounds should be tied with their respective source grounds and brought back to the power supply ground separately from the output load ground returns. Bringing the ground returns for the output loads back to the supply separately will keep large signal currents from interfering with the Stable AC input ground references. The exposed-DAP of the LM4836MTE package must be tied to ground.

#### POWER SUPPLY BYPASSING

As with any power amplifier, proper supply bypassing is critical for low noise performance and high power supply rejection. The capacitor location on both the bypass and power supply pins should be as close to the device as possible. The effect of a larger half supply bypass capacitor is improved PSRR due to increased half-supply stability. Typical applications employ a 5 volt regulator with 10 µF and a 0.1 µF bypass capacitors which aid in supply stability, but do not eliminate the need for bypassing the supply nodes of the LM4836. The selection of bypass capacitors, especially C  $_{\rm B},$ is thus dependent upon desired PSRR requirements, desired turn on time, click and pop performance as explained in the section, Proper Selection of External Components, system cost, and size constraints. It is also recommended to decouple each of the  $V_{\text{DD}}$  pins with a  $0.1 \mu F$  capacitor to ground.

#### PROPER SELECTION OF EXTERNAL COMPONENTS

Proper selection of external components in applications using integrated power amplifiers is critical to optimize device and system performance. While the LM4836 is tolerant of external component combinations, consideration to component values must be used to maximize overall system quality.

The LM4836's bridged amplifier should be used in low gain configurations to minimize THD+N values, and maximize the

### Application Information (Continued)

signal to noise ratio. Low gain configurations require large input signals to obtain a given output power. Input signals equal to or greater than 1Vrms are available from sources such as audio codecs.

Besides gain, one of the major considerations is the closedloop bandwidth of the amplifier. To a large extent, the bandwidth is dictated by the choice of external components shown in *Figure 1*. Both the input coupling capacitor,  $C_1$ , and the output coupling capacitor form first order high pass filters which limit low frequency response given in Equations 4 and 5

$$f_{IC} = 1/(2\pi R_i C_i)$$
 (4)  
 $f_{OC} = 1/(2\pi R_I C_O)$  (5)

These values should be chosen based on required frequency response.

#### Selection of Input and Output Capacitor Size

Large input and output capacitors are both expensive and space hungry for portable designs. Clearly, a certain sized capacitor is needed to couple in low frequencies without severe attenuation. In many cases the speakers used in portable systems, whether internal or external, have little ability to reproduce signals below 100 Hz–150 Hz. In this case, using a large input or output capacitor may not increase system performance.

In addition to system cost and size, click and pop performance is effected by the size of the input coupling capacitor,  $C_i$ . A larger input coupling capacitor requires more charge to reach its quiescent DC voltage (nominally 1/2 V<sub>DD</sub>.) This charge comes from the output through the feedback and is apt to create pops once the device is enabled. By minimizing the capacitor size based on necessary low frequency response, turn-on pops can be minimized.

#### CLICK AND POP CIRCUITRY

The LM4836 contains circuitry to minimize turn-on transients or "click and pops". In this case, turn-on refers to either power supply turn-on or the device coming out of shutdown mode. When the device is turning on, the amplifiers are internally muted. An internal current source ramps up the voltage of the bypass pin. Both the inputs and outputs ideally track the voltage at the bypass pin. The device will remain in mute mode until the bypass pin has reached its half supply voltage, 1/2 V<sub>DD</sub>. As soon as the bypass node is stable, the device will become fully operational.

Although the bypass pin current source cannot be modified, the size of the bypass capacitor,  $C_{\rm B},$  can be changed to alter the device turn-on time and the amount of "click and pop". By increasing  $C_{\rm B},$  the amount of turn-on pop can be reduced. However, the trade-off for using a larger bypass capacitor is an increase in the turn-on time for the device. Reducing  $C_{\rm B}$  will decrease turn-on time and increase "click and pop".

There is a linear relationship between the size of  $C_B$  and the turn-on time. Here are some typical turn-on times for different values of  $C_B$ :

| CB      | Ton    |
|---------|--------|
| 0.01 µF | 2 ms   |
| 0.1 µF  | 20 ms  |
| 0.22 µF | 42 ms  |
| 0.47 µF | 84 ms  |
| 1.0 µF  | 200 ms |
| 4.7 µF  | 1sec   |

In order to eliminate "click and pop", all capacitors must be discharged before turn-on. Rapid on/off switching of the device or shutdown function may cause the "click and pop" circuitry to not operate fully, resulting in increased "click and pop" noise.

In systems where the line out and headphone jack are the same, the output coupling cap,  $C_{\rm O}$ , is of particular concern.  $C_{\rm O}$  is chosen for a desired cutoff frequency with a headphone load. This desired cutoff frequency will change when the headphone load is replaced by a high impedance line out load(powered speakers). The input impedance of headphones are typically between 32 $\Omega$  and 64 $\Omega$ . Whereas, the input impedance of powered speakers can vary from 1k $\Omega$  to 100k $\Omega$ . As the RC time constant of the load and the output coupling capacitor increases, the turn off transients are increased.

To improve click and pop performance in this situation, external resistor R7 should be added as shown in Figure 3. The recommended value for R7 is between 150 $\Omega$  to 1k $\Omega$ . To achieve virtually clickless and popless performance R7 = 150 $\Omega$ , C<sub>o</sub> = 220 $\mu$ F, and C<sub>B</sub> = 1.0 $\mu$ F should be used. Lower values of R7 will result in better click and pop performance. However, it should be understood that lower resistance values of R7 will increase current consumption.

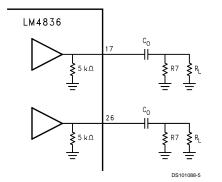


FIGURE 2. Resistor for Varying Output Loads

#### DOCKING STATION

In an application such as a notebook computer, docking station or line level outputs may be required. Pin 9 and Pin 13 can drive loads greater than  $1k\Omega$  rail to rail. These pins are tied to the output of the input op-amp to drive powered speakers and other high impedance loads. Output coupling capacitors need to be placed in series with the load. The recommended values of the capacitors are between  $0.33\mu$ F to  $1.0\mu$ F with the positive side of the capacitors toward the IC. The outputs of the docking station pins cannot be attenuated

### Application Information (Continued)

with the DC volume control. However the gain of the outputs can be configured by adjusting the feedback and input resistors for the input op-amp. The input op-amp is in an inverting configuration where the gain is:

#### $R_F / R_i = - A_v$

Note that by adjusting the gain of the input op-amp the overall gain of the output amplifiers are also affected. Although the single ended outputs of the output amplifiers can be used to drive line level outputs, it is recommended to use Pins 9 and 13 to achieve better performance.

#### MUX CONTROL

The LM4836 contains two pairs of inputs. The Mux Contol pin controls wihch set of inputs are selected. Left In 1 and Right In 1 are selected when Pin 2 is given a logic level low. Left In 2 and Right In 2 are selected whenever a logic level high is placed on Pin 2.

#### BEEP DETECT FUNCTION

The Beep Detect pin (pin 11) is a mono input that detects the presence of a beep signal. When a signal greater than  $2.5V_{P-P}$  (or 1/2  $V_{DD}$ ) is present at pin 11, the Beep Detect circuitry will enable the bridged amplifiers. Beep in signals less than 2.5V  $_{\rm P\mbox{-}P}$  (or 1/2  $V_{\rm DD})$  will not trigger the Beep Detect circuitry. When triggered, the Beep Detect circuitry will enable the bridged amplifiers regardless of the state of the Mute, Volume Control, or HP sense pins. The Beep Detect pin will not pass the beep signal to the output. As shown in the Fig. 2. a 200k $\Omega$  resistor is placed in series with the input capacitor. This 200k $\Omega$  resistor can be changed to vary the amplitude of the beep in signal. Higher values of the resistor will reduce the amplifier gain and attenuate the beep in signal. These resistors are required in order for the beep signal to pass to the output. In cases where system beeps are required when the system is in a suspended mode, the LM4836 must be brought out of shutdown before the beep in signal is input.

#### SHUTDOWN FUNCTION

In order to reduce power consumption while not in use, the LM4836 contains a shutdown pin to externally turn off the bias circuitry. The LM4836 will shutdown when a logic high is placed on the shutdown pin. The trigger point between a logic low and logic high level is typically half supply. It is best to switch between ground and the supply V<sub>DD</sub> to provide maximum device performance. By switching the shutdown pin to V<sub>DD</sub>, the LM4836 supply current draw will be minimized. While the device will be disabled with shutdown pin voltages less than V<sub>DD</sub>, the idle current may be greater than the typical value of 0.2  $\mu$ A.The shutdown pin should not be floated, since this may result in an undetermined state.

In many applications, a microcontroller or microprocessor output is used to control the shutdown circuitry which provides a quick, smooth transition into shutdown. Another solution is to use a single-pole, single-throw switch in conjuction with an external pull-up resistor. When the switch is closed, the shutdown pin is connected to ground and enables the amplifier. If the switch is open, then the external pull-up resistor will shutdown the LM4836. This scheme prevents the shutdown pin from floating.

#### MUTE FUNCTION

By placing a logic level high on the mute pin (pin5), the outputs of the amplifiers and pins 9 and 13 will be muted. The beep in signal will be output even if the LM4836 is muted. The mute pin must not be floated.

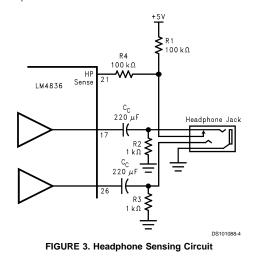
#### HP SENSE FUNCTION

The LM4836 possesses a headphone sense pin (pin 21) that mutes the bridged amplifier, when given a logic high, so that headphone or line out operation can occur while the bridged connected load will be muted.

Figure 3 shows the implementation of the LM4836's headphone control function using a single-supply. The voltage divider of R1 and R2 set the voltage at the HP sense pin (pin 21) to be approximately 50 mV when there are no headphones plugged into the system. This logic-low voltage at the HP sense pin enables the bridged power amplifiers. Resistor R4 limits the amount of current flowing out of the HP sense pin when the voltage at that pin goes below ground resulting from the music coming from the headphone amplifier. Since the threshold of the HP sense pin is set at 4V ( or 80% V<sub>DD</sub>), the output swing cannot cause false triggering.

When a set of headphones are plugged into the system, the contact pin of the headphone jack is disconnected from the signal pin, interrupting the voltage divider set up by resistors R1 and R2. Resistor R1 then pulls up the HP sense pin, enabling the headphone function and disabling the bridged amplifier. The headphone amplifier then drives the headphones, whose impedance is in parallel with resistor R2 and R3. Also shown in *Figure 3* are the electrical connections for the headphone jack and plug. A 3-wire plug consists of a Tip, Ring and Sleeve, where the Tip and Ring are signal carrying conductors and the Sleeve is the common ground return. One control pin contact for each headphone jack is sufficient to indicate that the user has inserted a plug into a jack and that another mode of operation is desired.

The LM4836 can be used to drive both a bridged 8 $\Omega$  internal speaker and a pair of 32 $\Omega$  speakers without using the HP sense circuit. In this case the HP sense is controlled by a microprocessor or a switch.



### Application Information (Continued)

#### BASS BOOST FUNCTION

The Bass Boost Function can be toggled by changing the logic at pin 19. A logic low will switch the power amplifiers to bass boost mode. In bass boost mode the low frequency gain of the amplifier is set by the external capacitor. Whereas a logic high sets the amplifiers to unity gain.

In some cases a designer may want to improve the low frequency response of the bridged amplifier or incorporate a bass boost feature. This bass boost can be useful in systems where speakers are housed in small enclosures. If the designer wishes to disable the bass boost feature, pin 19 can be tied to  $V_{\rm DD}.$ 

When bass boost is enabled, the output amplifiers will be internally set at a gain of 2 at low frequencies (gain of 4 in bridged mode). As shown in Figure 2,  $C_{BASS}$  sets the cutoff frequency for the bass boost. At low frequencies the capacitor will be virtually an open circuit. At high frequencies the capacitor will be virtually a short circuit. As a result of this, the gain of the bridge amplifier is increased at low frequencies. A first order pole is formed with a corner frequency at:

 $f_c = 1/(2\pi 10 k\Omega C_{BASS})$ 

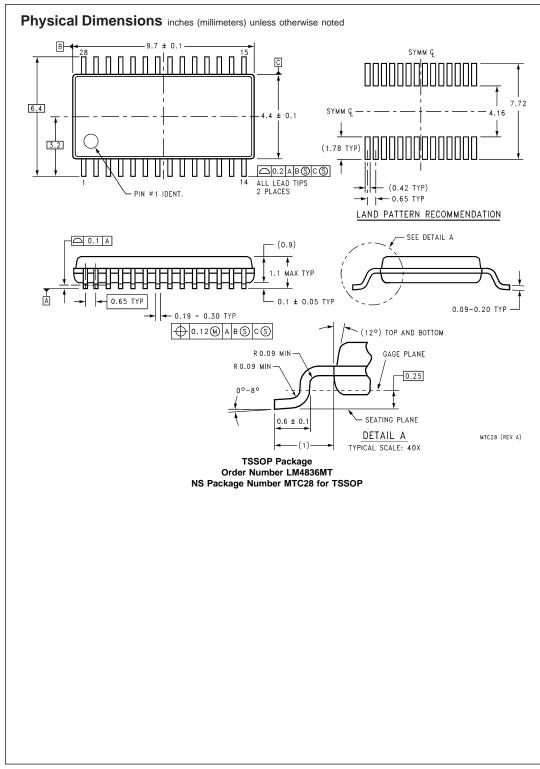
The resulting low frequency differential gain of this bridged amplifier becomes:

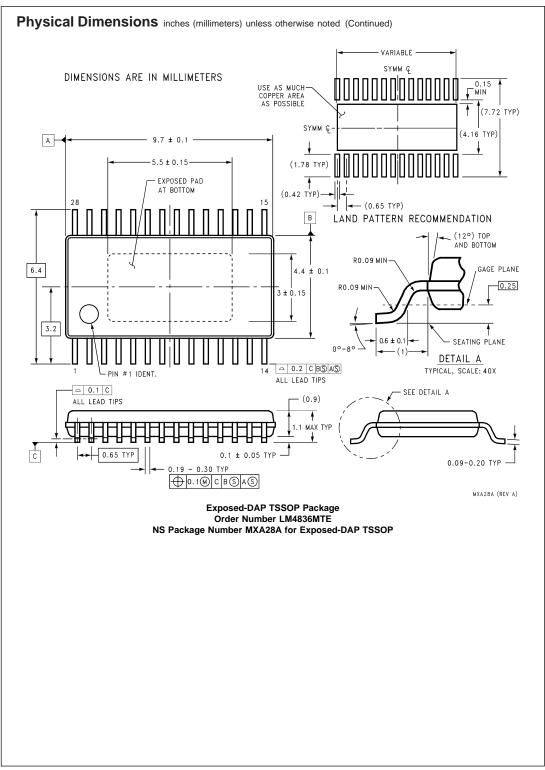
#### $2(10k\Omega + 10k\Omega)/10k\Omega = 4$

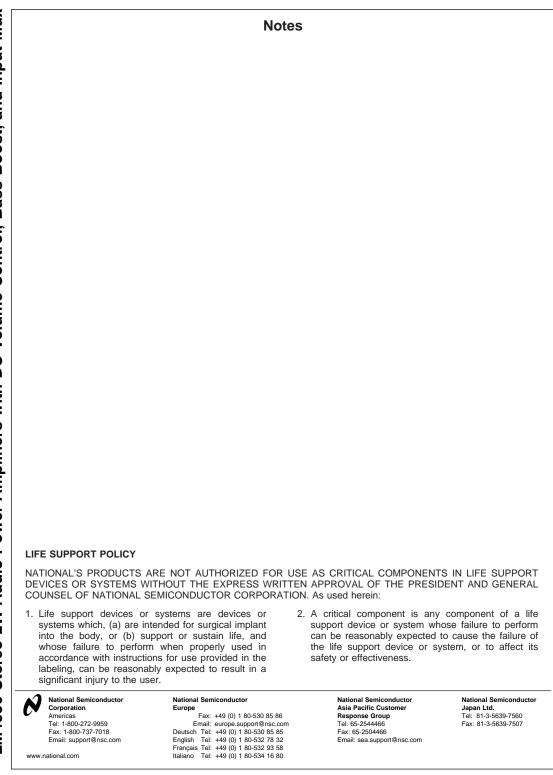
With  $C_{BASS}$  = 0.1  $\mu F$ , a first order pole is formed with a corner frequency of 160 Hz. The low frequency boost formulas assume that  $C_{O},\ C_{i},\ f_{IC},\ f_{OC}$  allow the appropriate low frequency response as explained in the **Proper Selection of External Components** section. See the **Typical Performance Characteristics** section for a graph that includes bass boost performance with various values of  $C_{BASS}$ .

#### DC VOLUME CONTROL

The DC voltage at the DC Volume Control pin (pin 5) determines the attenuation of output of the amplifiers. If the DC potential of pin 5 is above 4V (typical 80%  $V_{DD}$ ) the internal amplifiers are set at unity gain. The attenuator range is from 0 dB (pin 5 = 80%  $V_{DD}$ ) to -81 dB (pin 5 = 0V). Any DC voltage greater than 4V (or 80%  $V_{DD}$ ) will result in a gain of unity. Refer to the **Typical Performance Characteristics** of the DC volume Control pin.







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